

N-Channel Enhancement Mode MOSFET

TDM31056

DESCRIPTION

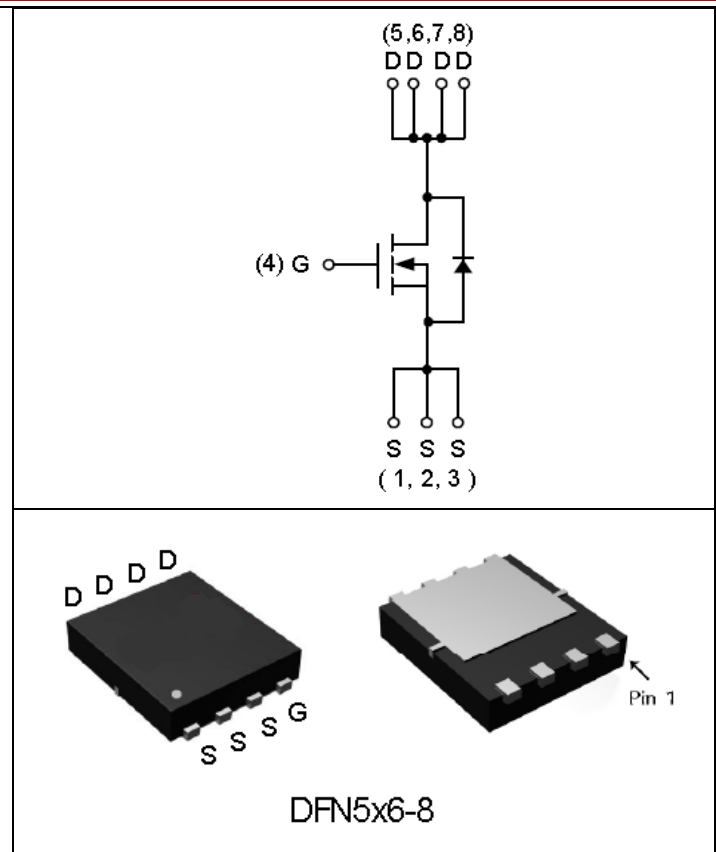
The TDM31056 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

GENERAL FEATURES

- RDS(ON) < 18.2mΩ @ VGS=4.5V
RDS(ON) < 13.5mΩ @ VGS=10V
- High Power and current handling capability
- Lead free product is available
- DFN5X6-8 Package

Application

- PWM applications
- Load switch
- Power management
- Hard Switched and High Frequency Circuits



ABSOLUTE MAXIMUM RATINGS(TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	100	V
Gate-Source Voltage	VGS	+20	V
Diode Continuous Forward Current	IS (Tc=25°C)	21	A
Drain Current @ Continuous	ID (Tc=25°C)	43	A
	ID (Tc=100°C)	27	A
Pulsed Drain Current	IDM (Tc=25°C)	172	A
Maximum Power Dissipation	Pd(Tc=25°C)	52	W
	Pd(Tc=100°C)	20	W
Drain Current @ Continuous	ID (TA=25°C)	8.78	A
	ID (TA=70°C)	7.03	A
Maximum Power Dissipation	Pd(TA=25°C)	2.08	W
	Pd(TA=70°C)	1.33	W
Thermal Resistance,Junction-to-Case	RθJC	2.4	°C/W
Thermal Resistance,Junction-to-Ambient (Note 1)	RθJA	60	°C/W
Avalanche Current, Single pulse	IAS(L=0.5mH)	18	A
Avalanche Energy, Single pulse	EAS(L=0.5mH)	81	mJ
Maximum Operating Junction Temperature	TJ	150	°C
Storage Temperature Range	TSTG	-55 To 150	°C

ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

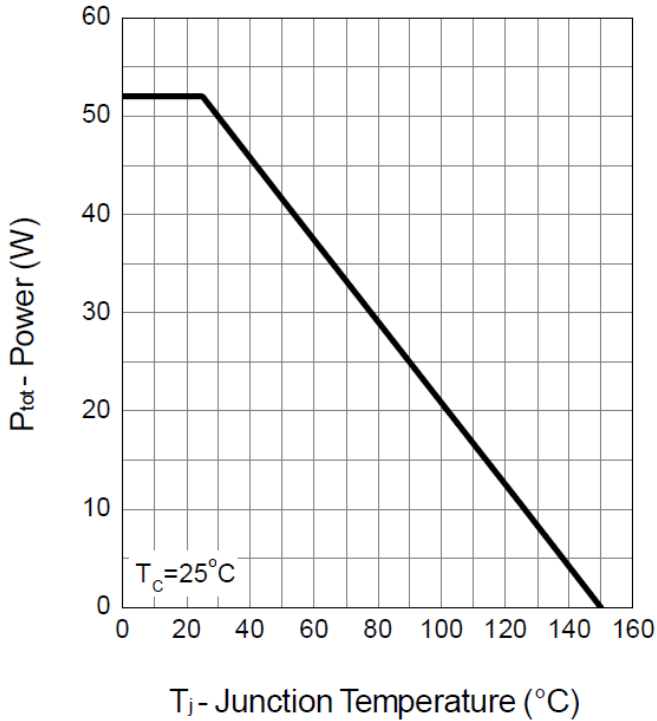
Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	100	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=80V, V_{GS}=0V$	-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1	2	3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=15A$	-	14	18.2	m Ω
	$R_{DS(ON)}$	$V_{GS}=10V, I_D=20A$	-	11.2	13.5	m Ω
DYNAMIC CHARACTERISTICS (Note3)						
Gate Resistance	R_G	$V_{DS}=0V, V_{GS}=0V, F=1.0MHz$	-	1.0	-	Ω
Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V, F=1.0MHz$	-	1440	1880	PF
Output Capacitance	C_{oss}		-	405	-	PF
Reverse Transfer Capacitance	C_{rss}		-	30	-	PF
SWITCHING CHARACTERISTICS (Note 3)						
Turn-on Delay Time	$t_{d(on)}$	$V_{DS}=30V, R_L=30\Omega, V_{GEN}=10V, R_G=6\Omega, I_D=1A$	-	16	29	nS
Turn-on Rise Time	t_r		-	7	13	nS
Turn-Off Delay Time	$t_{d(off)}$		-	38	69	nS
Turn-Off Fall Time	t_f		-	41	74	nS
Total Gate Charge	Q_g	$V_{DS}=50V, I_D=20A, V_{GS}=10V$	-	28	40	nC
Gate-Source Charge	Q_{gs}		-	4.8	-	nC
Gate-Drain Charge	Q_{gd}		-	5.8	-	nC
Body Diode Reverse Recovery Time	T_{rr}	$I_F=20A, di/dt=100A/\mu s$	-	45	-	nS
Body Diode Reverse Recovery Charge	Q_{rr}		-	86	-	nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode Forward Voltage (Note 2)	V_{SD}	$V_{GS}=0V, I_S=2A$	-	0.8	1.3	V

NOTES:

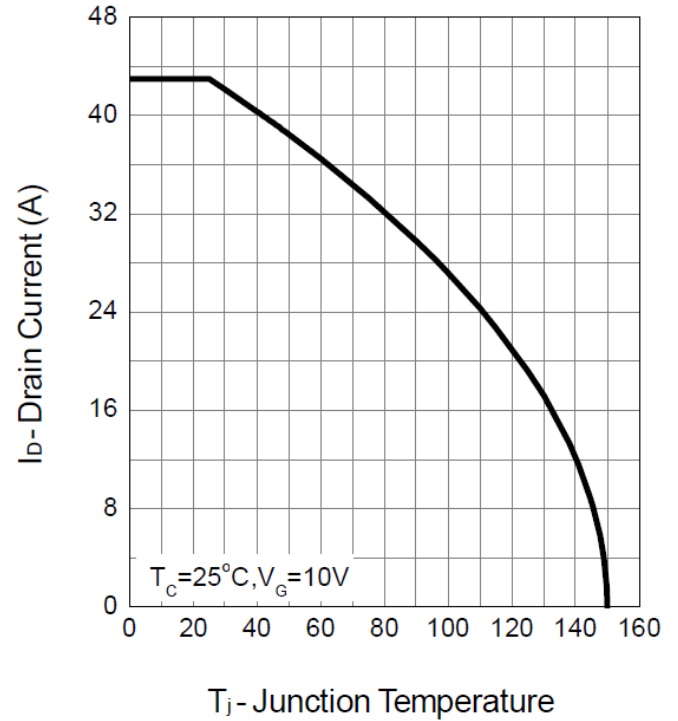
1. Pulse width limited by max. junction temperature.
2. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production testing

Typical Operating Characteristics

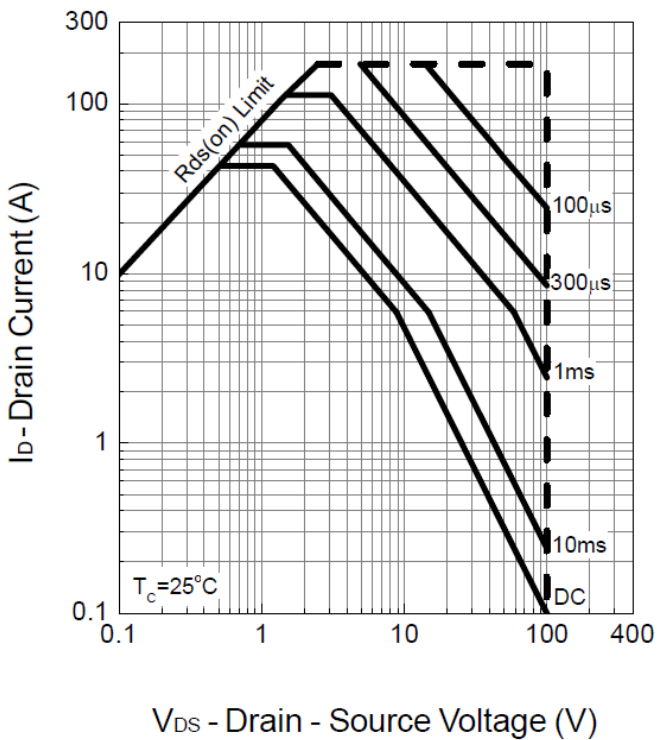
Power Dissipation



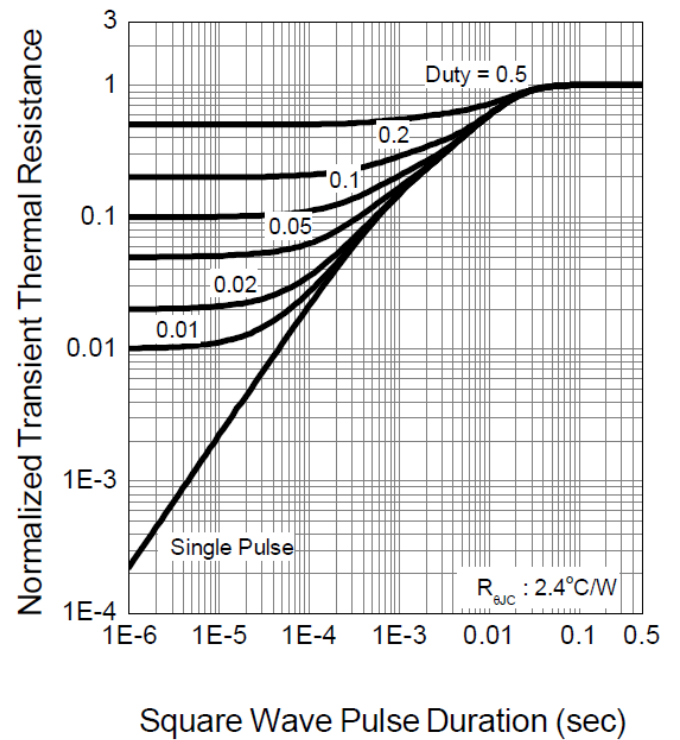
Drain Current



Safe Operation Area

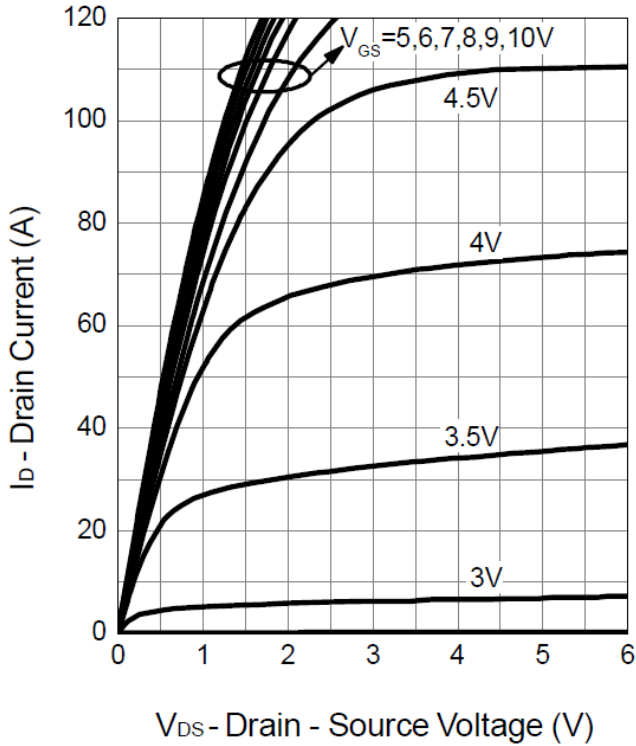


Thermal Transient Impedance

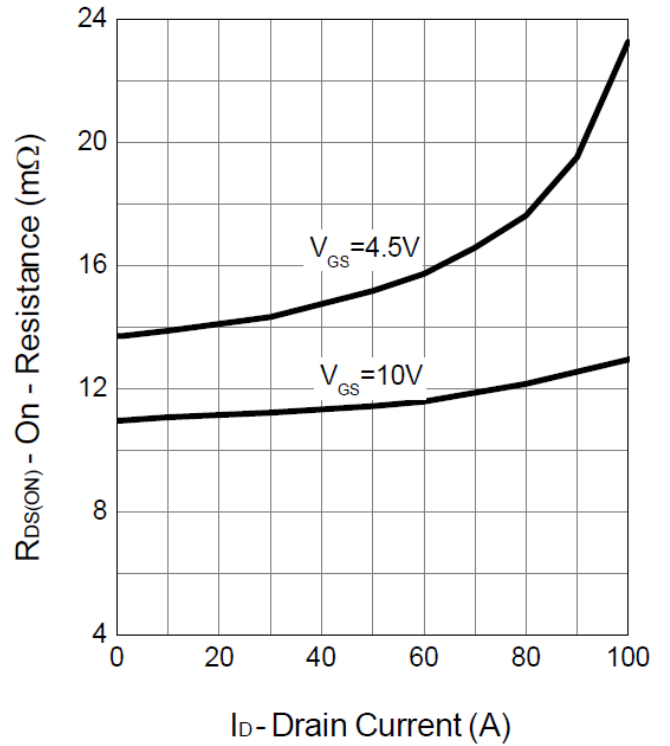


Typical Operating Characteristics (Cont.)

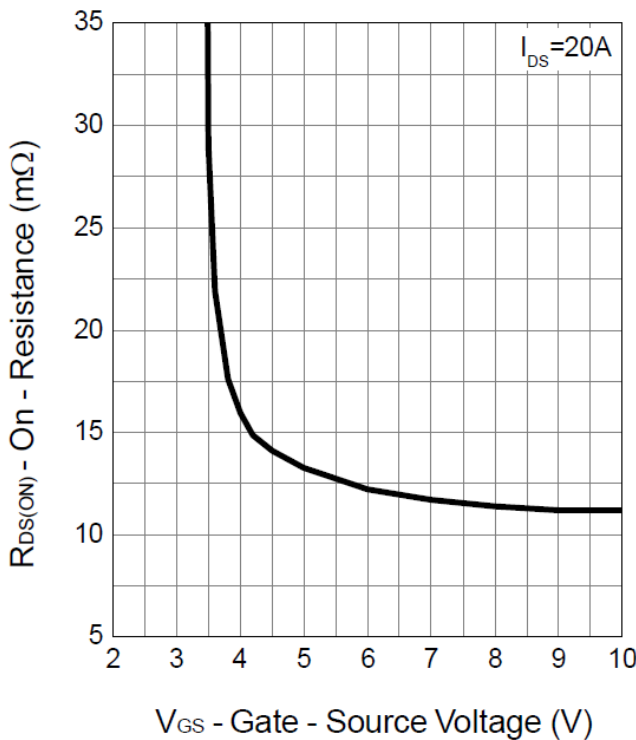
Output Characteristics



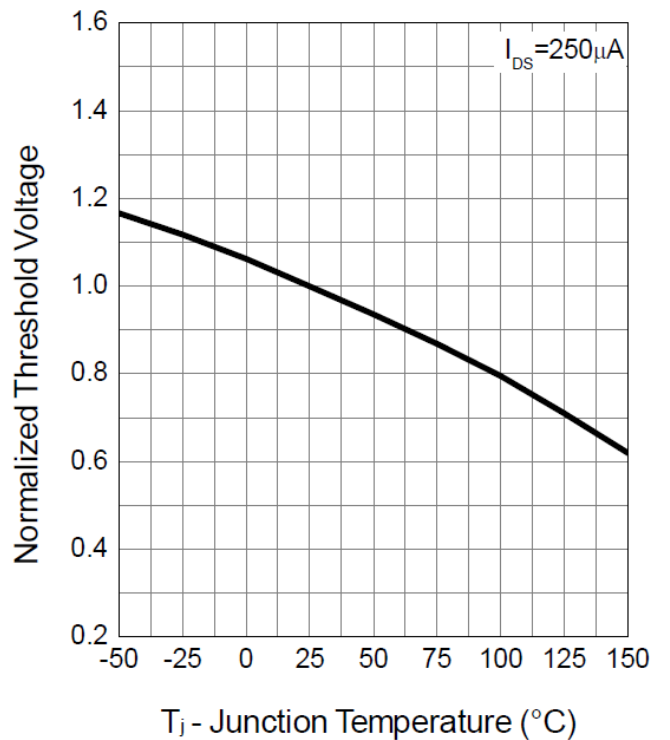
Drain-Source On Resistance



Gate-Source On Resistance

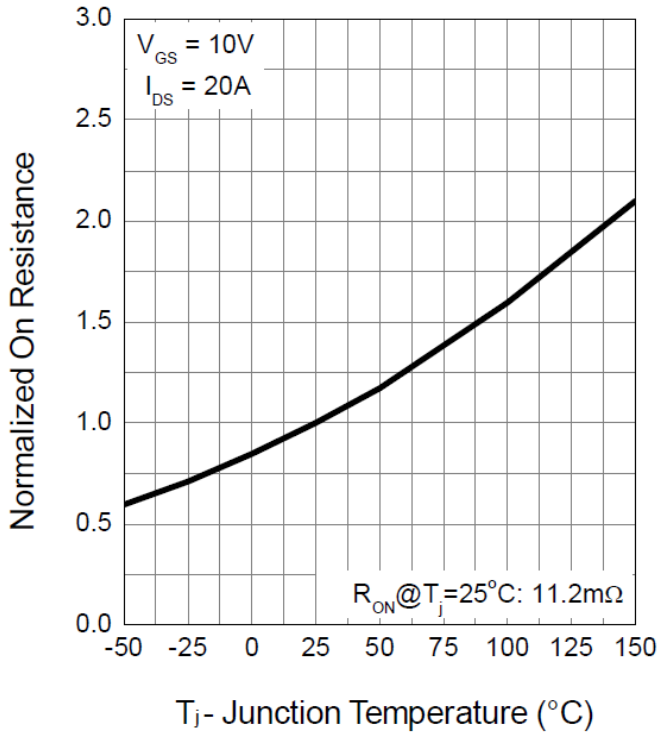


Gate Threshold Voltage

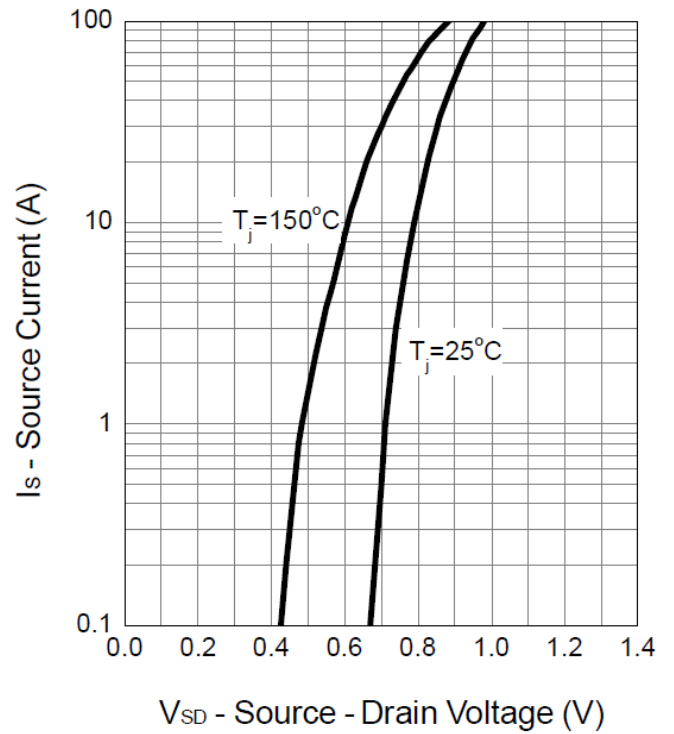


Typical Operating Characteristics (Cont.)

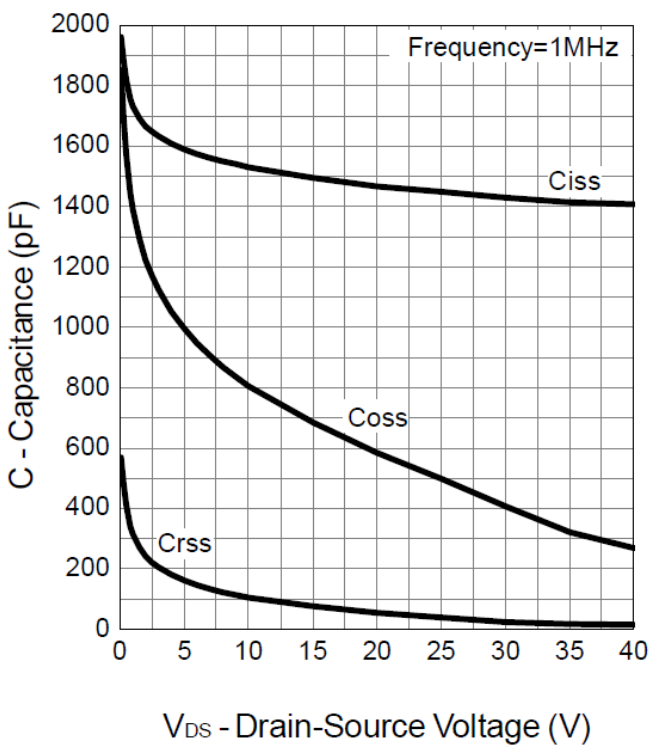
Drain-Source On Resistance



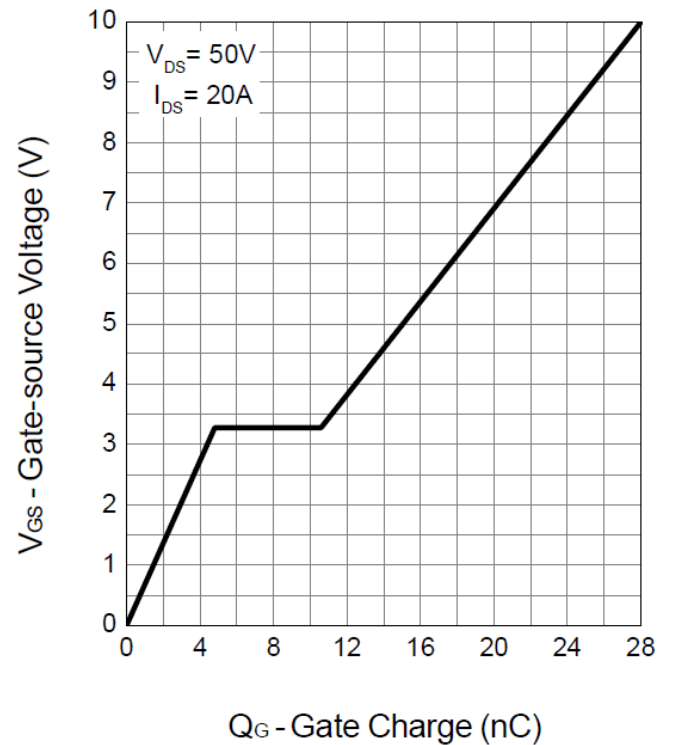
Source-Drain Diode Forward



Capacitance

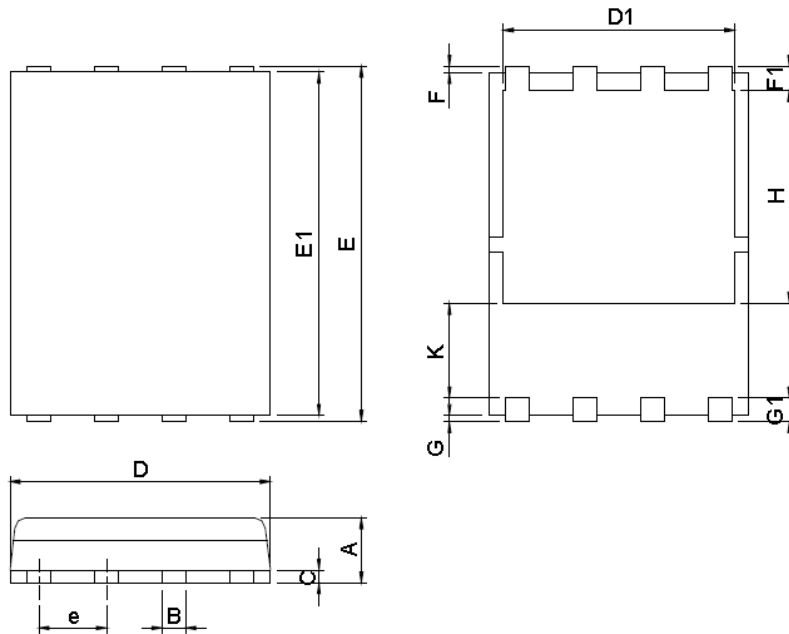


Gate Charge



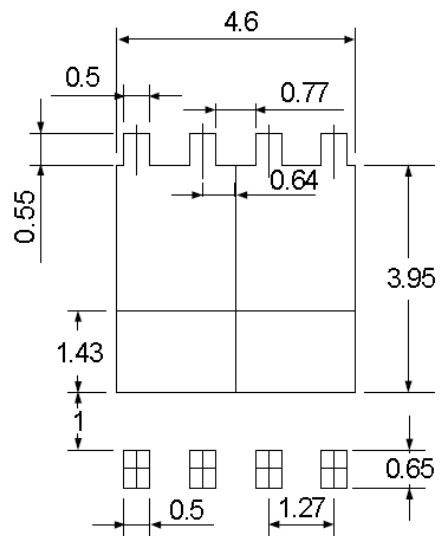
Package Information

DFN5*6-8 Package



DIMENSIONS	DFN5x6-8			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	0.90	1.20	0.035	0.047
B	0.3	0.51	0.012	0.020
C	0.19	0.25	0.007	0.010
D	4.80	5.30	0.189	0.209
D1	4.00	4.40	0.157	0.173
E	5.90	6.20	0.232	0.244
E1	5.50	5.80	0.217	0.228
e	1.27 BSC		0.050 BSC	
F	0.05	0.30	0.002	0.012
F1	0.35	0.75	0.014	0.030
G	0.05	0.30	0.002	0.012
G1	0.35	0.75	0.014	0.030
H	3.34	3.9	0.131	0.154
K	0.762	-	0.03	-

RECOMMENDED LAND PATTERN



UNIT: mm

Note : 1.Dimension D, D1,D2 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 10 mil.

Design Notes

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